

# 660nm Parallel Light Emitting Diode

## 1. GENERAL DESCRIPTION

T46-660-H5 is serials of LEDs designed for optical encoder,with precision optical design.

## 2. FEATURES

- TO-46K can type with glass lens.
- Peak wavelength 660nm.
- Parallel light emitting.
- High reliability.

## 3. APPLICATION

- Optical encoder.
- Optical switches
- Grating scale.
- Factory application.

## 4. ABSOLUTE MAXIMUM RATINGS AT Ta=25°C

ITEM	SYMBOL	MAXIMUM RATING	UNIT
Power Dissipation	P <sub>D</sub>	150	mW
forward current	I <sub>F</sub>	60	mA
Reverse voltage	V <sub>R</sub>	5	V
Operating temperature range	T <sub>opr.</sub>	-30 to +100	°C
Storage temperature range	T <sub>stg.</sub>	-40 to +125	°C
soldering temperature (see Note 1)	T <sub>sol.</sub>	260	°C

Note1:For MAX. 5 seconds at the position of 2mm from the resin edge.

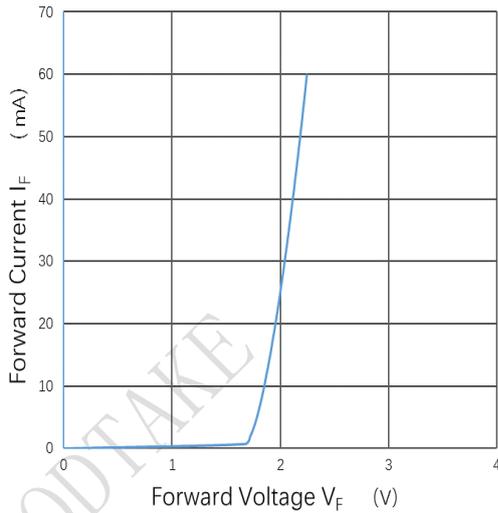
## 5. ELECTRIO-OPTICAL CHARACTERISTICS AT Ta=25°C

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
Forward Voltage	V <sub>F</sub>	1.85	2.0	2.4	V	L <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>			10	μ A	V <sub>R</sub> =5V
Radiant Intensity	P <sub>o</sub>		6.9		mW	L <sub>F</sub> =20mA
Peak Wavelength	λ <sub>p</sub>		660		nm	L <sub>F</sub> =20mA
Spectral Width	Δλ		± 10		nm	L <sub>F</sub> =20mA
Beam Diameter	φ <sub>B</sub>		5		mm	L=3mm
Half Angle	Δ θ	-	± 9	-	deg.	-

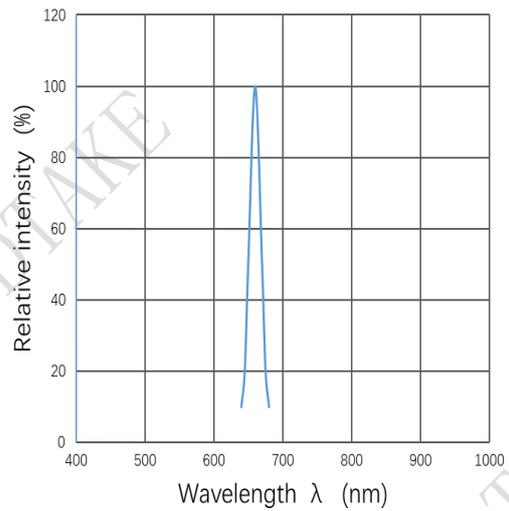
**6. TYPICAL ELECTRICAL/OPTICAL CHARACTERISTICS CURVES**

(25°C Ambient Temperature Unless Otherwise Noted)

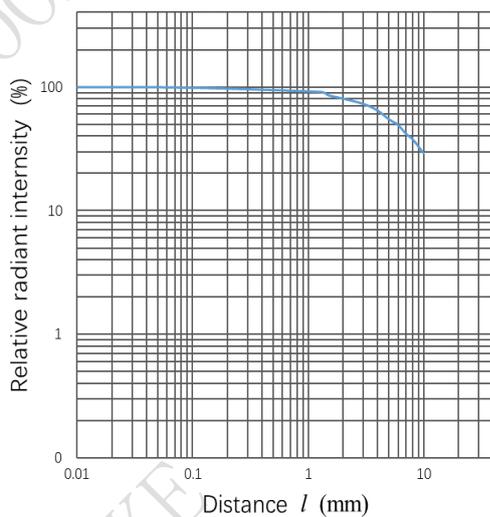
**Forward I-V Curve**



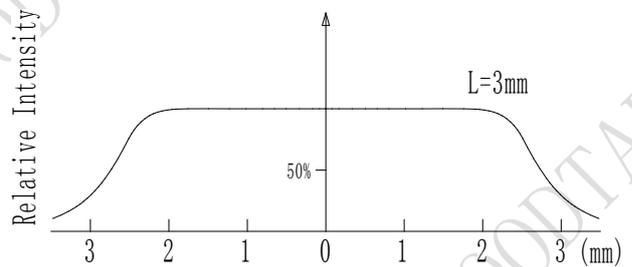
**Spectrum**



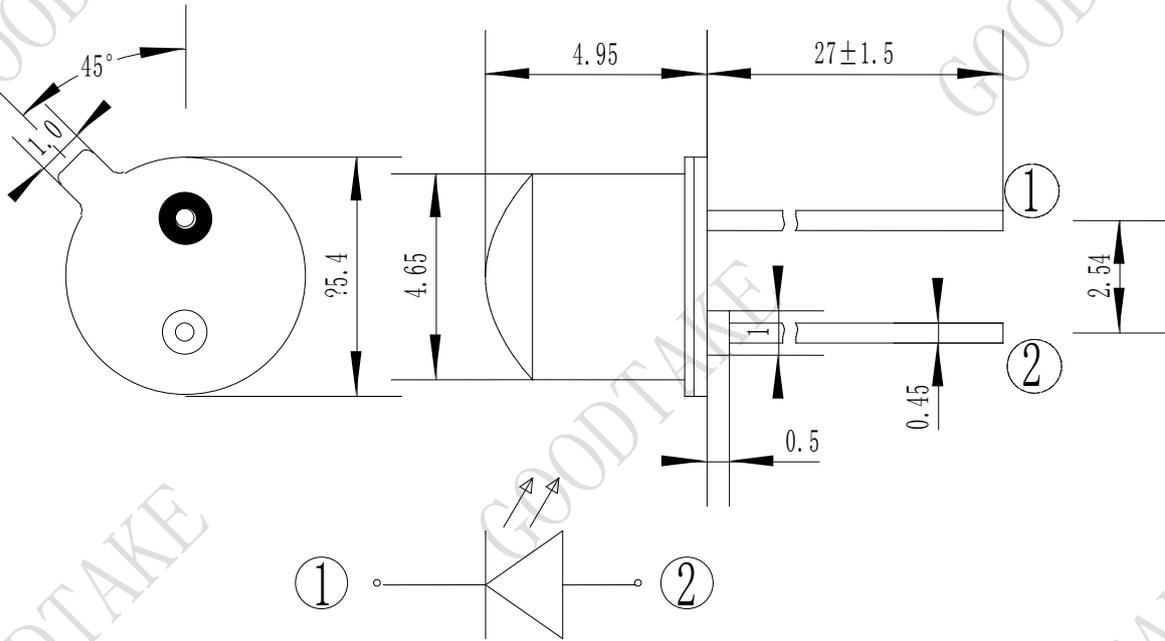
**Radiant intensity by distance**



**Radiation Pattern**



**7. DIMENSIONS IN MM**



**Notes**

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.2 unless otherwise noted.

**8.Storage**

Do not open the sealed moisture-proof bag before ready to use.  
Storage in controlled environment of temperature =40°C or below, with maximum humidity <90%.

**9. Manual Soldering**

Use only temperature-controlled soldering station with 25 watt iron or less, maximum tip temperature always below 350°C. By putting the solder tip so it touches both the PCB board pad (applied with solder) and the device’s terminal pin, finish soldering within 3 seconds each time, leave two seconds and more intervals before doing another soldering. Be careful the iron tip should not touch the device package body to avoid damage.